

(V)	Preli	minary	Specif	ications
()	Final	Specif	ication	S

Module	11.6"(11.57") WXGA Color TFT-LCD with LED Backlight design				
Model Name	B11.6XW02 V0 (H/W:0A)				
Note (🗭)	LED Backlight with driving circuit design				

Customer	Date	Approved by	Date
			MM/DD/YYYY
Checked & Approved by	Date	Prepared by	
			02/13/2009
Note: This Specification is swithout notice.	subject to change		ting Division / es corporation



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Record of Revision

Ver	Version and Date		Old description						New Description				Remark	
0.1	2008/12/26	All	First Edition for Customer											
0.2	2009/01/07	1	Module: 11.6"			Module: 11.6" (11.57")				modified				
		<mark>34</mark>	EDID: TBD					EDIC):Adde	d				Added
0.3	2009/02/13	6	Rising: TBD(typ), TBD(max)			Response Time Rising: 6ms(typ), 8ms(max) Falling: 2ms(typ), 4ms(max)					Updated			
		15		LED Power Consumption and LED			LED	Power Time	` • •			LED	Updated	
				min	typ	max	unit			min	typ	max	unit	
			LED Power consumption		TBD	TBD	Watt	11	Power umption		2710	288 0	mWatt	
			LED Life-Time	TBD				LED Life-T	「ime	15000				-
		25	LVDS Conn	ector T	ype			LVDS Connector Type					Modified	
			Type / Part Number	IPEX 2	2 0455-04 itible	I0E-12	or	Type / Part IPEX 20455-040E-12A or compatible			\ or			
		31	Screw Hole Dep	oth and C	enter Po	sition	•	Screw Hole Depth and Center Position Attached				1	Updated	
		32	Shipping Label	Format:	TBD			Shipping Label Format:Added				Updated		
		33	Carton package	Carton package:TBD			Carton package: Added				Updated			
		34	Shipping packa	Shipping package of palletizing sequence:TBD			Shipping package of palletizing sequence:Added			e:Added	Updated			
		19	6.3 Integration I	nterface	and Pin	Assignr	ment	6.3 Integration Interface and Pin Assignment			ment	Modified		
			38 VLED	LED P	ower Su	pply 7V	-20V	38	VLED	LED P	ower Su	pply 6V	-21V	
			39 VLED	LED P	ower Su	pply 7V	-20V	39	VLED	LED P	ower Su	pply 6V	-21V	
			40 VLED	LED P	ower Su	pply 7V	-20V	40	VLED	LED P	ower Su	pply 6V	'-21V	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B116XW02 V0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the WXGA (1366(H) x 768(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B116XW02 V0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications						
Screen Diagonal	[mm]	11.6W"	11.6W"					
Active Area	[mm]	256.125 X	144.0					
Pixels H x V		1366x3(RG	iB) x 768					
Pixel Pitch	[mm]	0.1875 x 0.	1875					
Pixel Format		R.G.B. Ver	tical Stripe					
Display Mode		Normally W	/hite					
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]		points avera					
Luminance Uniformity		1.25 max. (5 points)						
Contrast Ratio		500:1 typ						
Response Time	[ms]	8 typ / 12 Max						
Nominal Input Voltage VDD	[Volt]	+3.3 typ.						
Power Consumption	[Watt]	4.0 max. (Ir	nclude Logic	and Blu po	wer)			
Weight	[Grams]	255g max.						
Physical Size without inverter,	[mm]		Min.	Тур.	Max.			
bracket.		Length	267.5	268.0	268.5			
		Width	161.0	161.5	162.0			
		Thickness	-	-	5.2			
Electrical Interface		1 channel LVDS						
Glass Thickness	[mm]	0.5						
Surface Treatment		Glare, Hardness 3H, Reflection <4%						
Support Color		262K colors	s (RGB 6-bi	t)				



Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

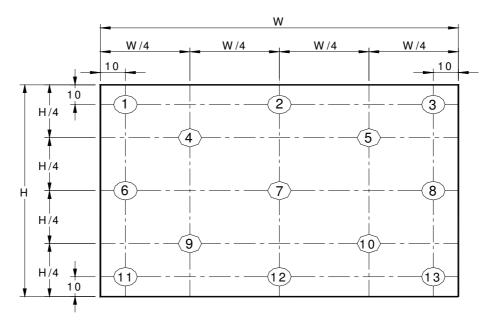
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	170	200	-	cd/m ²	1, 4, 5.
		$oldsymbol{ heta}$ R	Horizontal (Right)	40	45	-		
Viewing Aı	nale	<i>θ</i> L	CR = 10 (Left)	40	45	-	degree	4.0
Viewing Ai	igic	ф н	Vertical (Upper)	10	15	-		4, 9
		¢ ∟	CR = 10 (Lower)	30	35	-		
Luminan Uniformi		δ _{5P}	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ _{13P}	13 Points	-	-	1.60		2, 3, 4
Contrast R	Contrast Ratio			400	500	-		4, 6
Cross ta	lk	%				4		4, 7
		T _r	Rising	-	6	8		
Response ⁻	Гіте	T _f	Falling	-	2	4	msec	4, 8
		T _{RT}	Rising + Falling	-	8	12		
	Red	Rx		TBD	TBD	TBD		
	Hed	Ry		TBD	TBD	TBD		
	Green	Gx		TBD	TBD	TBD		
Color / Chromaticity	Green	Gy		TBD	TBD	TBD		
Coodinates	Blue	Bx	CIE 1931	TBD	TBD	TBD		4
	biue	Ву		TBD	TBD	TBD		
	\//bit-	Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

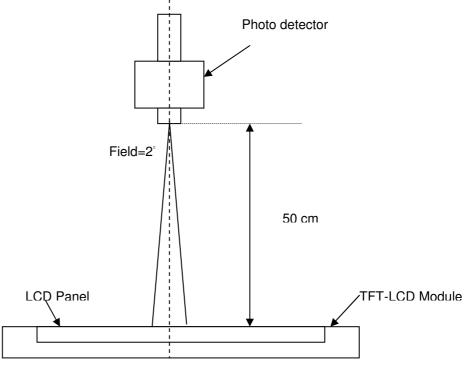
0		Maximum Brightness of five points
δ _{w5} =		Minimum Brightness of five points
2		Maximum Brightness of thirteen points
$\delta_{W13} =$		Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

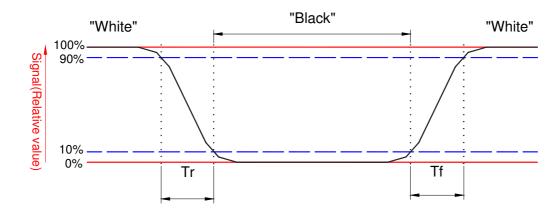
Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.





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Note 9. Definition of viewing angle

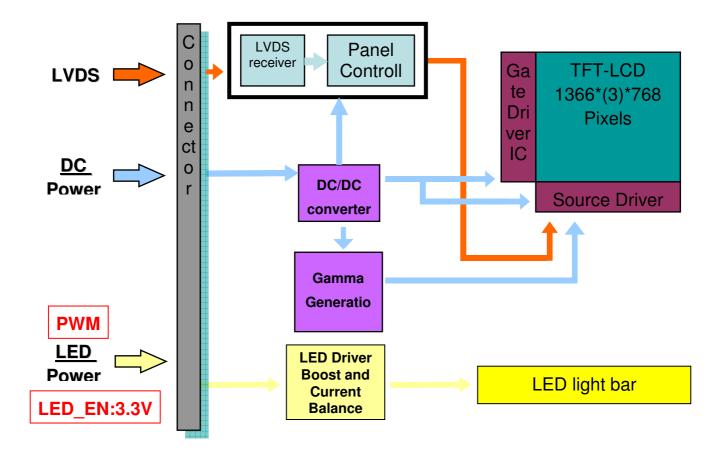
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 11.6 inches wide Color TFT/LCD 40 Pin (One CH/connector Module)





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

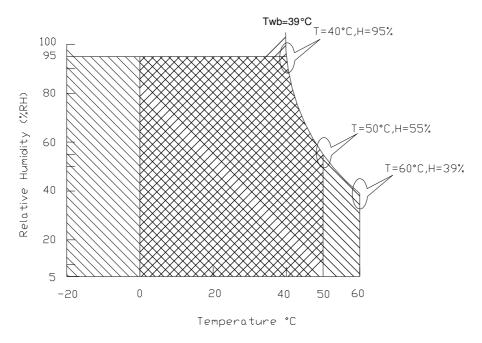
Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

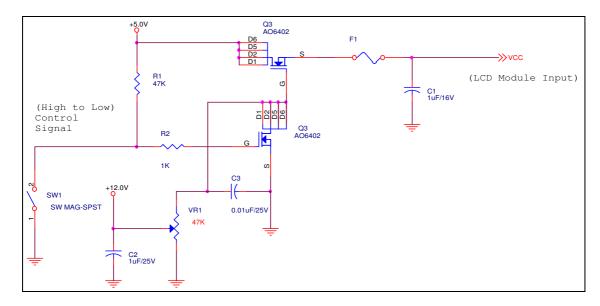
The power specification are measured under 25°C and frame frenquency under 60Hz

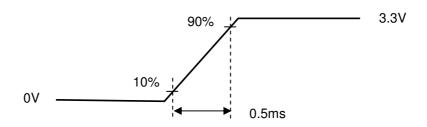
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.8	[Watt]	Note 1/2
IDD	IDD Current	-	350	450	[mA]	Note 1/2
lRush	Inrush Current	-	-	2000	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition







5.1.2 Signal Electrical Characteristics

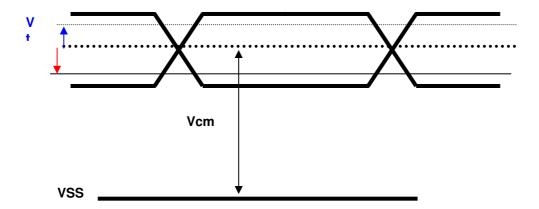
Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of THC63LVDF84A (Thine Electronics Inc.) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





LED Parameter guideline for LED driving selection (Ref. Remark 1)

Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	V _F	3.0	3.2	3.4	[Volt]	(Ta=25°ℂ)
LED Forward Current	I _F		20		[mA]	(Ta=25°C)
LED Power consumption	P _{LED}		2710	2880	[mWatt]	(Ta=25°C) Note 1
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25°C) I _F =20 mA Note 2
Output PWM frequency	F _{PWM}	100	200	20K	Hz	
Duty ratio		5		100	%	

P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency Note 1: Calculator value for reference

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1									13	66)
1st Line	R	G	В	R	G	В		R	G	В	R	G I	В
							1						
		•			•		1		•			•	
							•						
							•						
		•			•		•		•			•	
					•								
		•			•		1		•				
768th Line	R	G	В	R	G	В		R	G	В	R	G I	В



6.2 The input data format

RxCLKIN		/
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1
RxIN2	DE VS HS B5 B4	B3 B2

Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB) Red-pixel Data	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB) Green-pixel Data	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface and Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	AVDD	PowerSupply,3.3V(typical)
3	AVDD	PowerSupply,3.3V(typical)
4	DVDD	DDC 3.3Vpower
5	NC	No Connection (Reserve)
6	SCL	DDCClock
7	SDA	DDCData
8	Rin0-	-LVDSdifferential data input(R0-R5,G0)
9	Rin0+	+LVDSdifferential data input(R0-R5,G0)
10	GND	Ground
11	Rin1-	-LVDSdifferential data input(G1-G5,B0-B1)
12	Rin1+	+LVDSdifferential data input(G1-G5,B0-B1)
13	GND	Ground
14	Rin2-	-LVDSdifferential data input(B2-B5,HS,VS,DE)
15	Rin2+	+LVDSdifferential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	ClkIN-	-LVDSdifferential clock input
18	ClkIN+	+LVDSdifferential clock input
19	GND	Ground-Shield
20	NC	No Connection (Reserve)
21	NC	No Connection (Reserve)
22	GND	Ground-Shield
23	NC	No Connection (Reserve)
24	NC	No Connection (Reserve)
25	GND	Ground-Shield
26	NC	No Connection (Reserve)
27	NC	No Connection (Reserve)
28	GND	Ground-Shield
29	NC	No Connection (Reserve)
30	NC	No Connection (Reserve)
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)



	İ	i
35	PWM	System PWM Signal Input
36	LED_EN	LED enable pin(+3V Input)
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply 6V-21V
39	VLED	LED Power Supply 6V-21V
40	VLED	LED Power Supply 6V-21V

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B/L LABEL

S/N LABEL

Connector

Connector

Connector

Connector

Connector

Connector

Connector

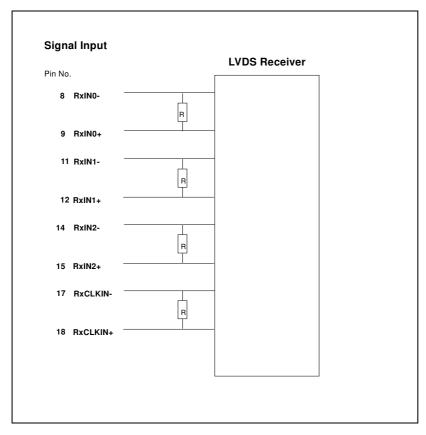
Note2: Input signals shall be low or High-impedance state when VDD is off.



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internal circuit of LVDS inputs are as following.

The module uses a 100ohm resistor between positive and negative data lines of each receiver input





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6.4 Interface Timing

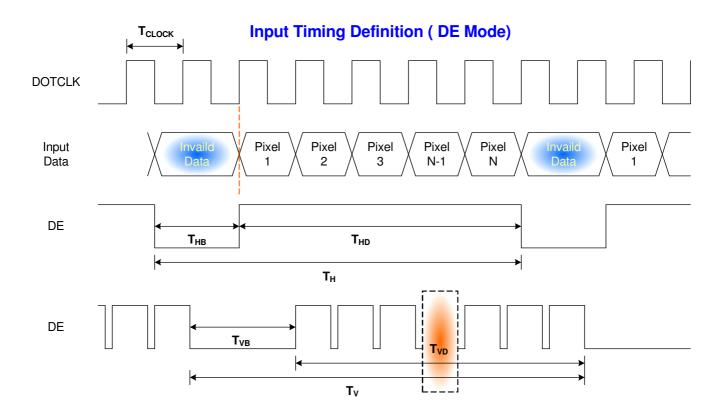
6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parai	neter	Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	50	60	-	Hz
Clock fr	equency	1/ T _{Clock}	TBD	TBD	TBD	MHz
	Period	T _V	803	TBD	-	
Vertical	Active	T _{VD}		TBD		T_Line
Section	Blanking	T _{VB}	TBD	TBD	-	
	Period	T _H	TBD	TBD	-	
Horizontal	Active	T _{HD}		TBD		T_{Clock}
Section	Blanking	T _{HB}	TBD	TBD	-	

Note: DE mode only

6.4.2 Timing diagram

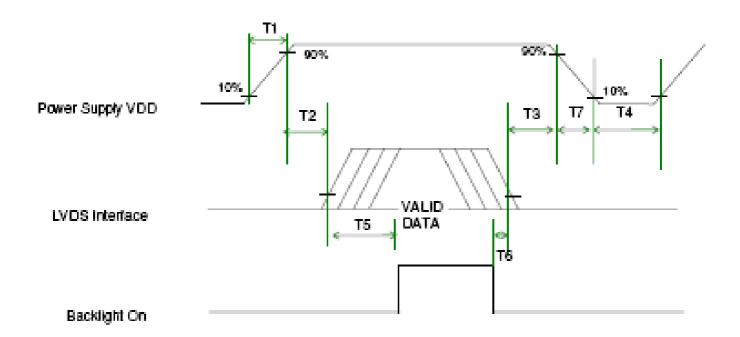




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6.5 Power ON/OFF Sequence

VDD power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



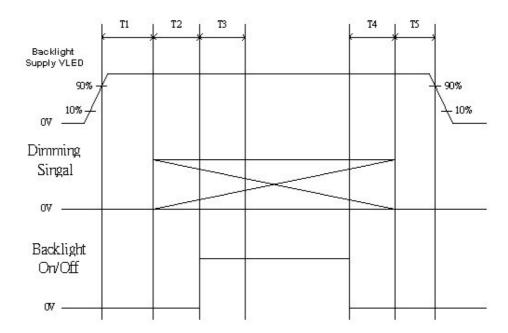
Power Sequence Timing

Parameter	Min.	Тур.	Max.	Units
T1	0.5	-	10	
T2	0	-	50	
Т3	0	-	50	
T4	400	-	-	ms
T5	200	-	-	
Т6	200	-	-	
Т7	0	-	10	



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LED on/off sequence is as follows. Interface signals are also shown in the chart.



		Values					
Symbol	Min	Тур	Max	Unit			
T1	10						
T2	10						
Т3	50			ms			
T4	0						
T5	10						

Note: The duty of LED dimming signal should be more than 5% in T2 and T3.



7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20455-040E-12A or compatible
Mating Housing/Part Number	IPEX 20453-040E-01 or compatible



8. LED Driving Specification

8.1 Connector Description

It is a intergrative interface and comibe into LVDS connector. The type and mating refer to section 7.

8.2 Pin Assignment

Ref. to 6.3



9. Vibration and Shock Test

9.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

9.2 Shock Test Spec:

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side



10. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

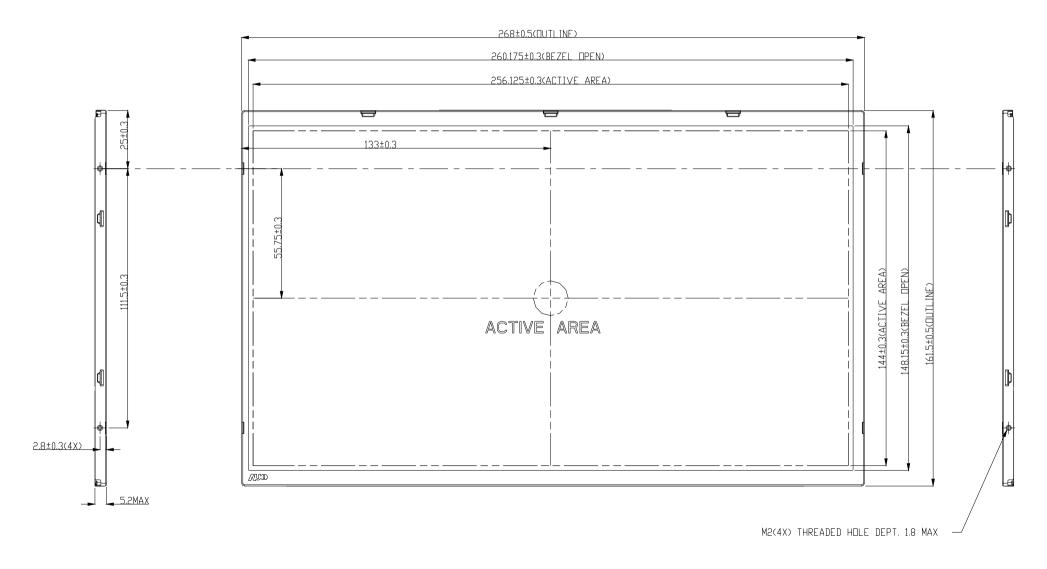
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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11. Mechanical Characteristics

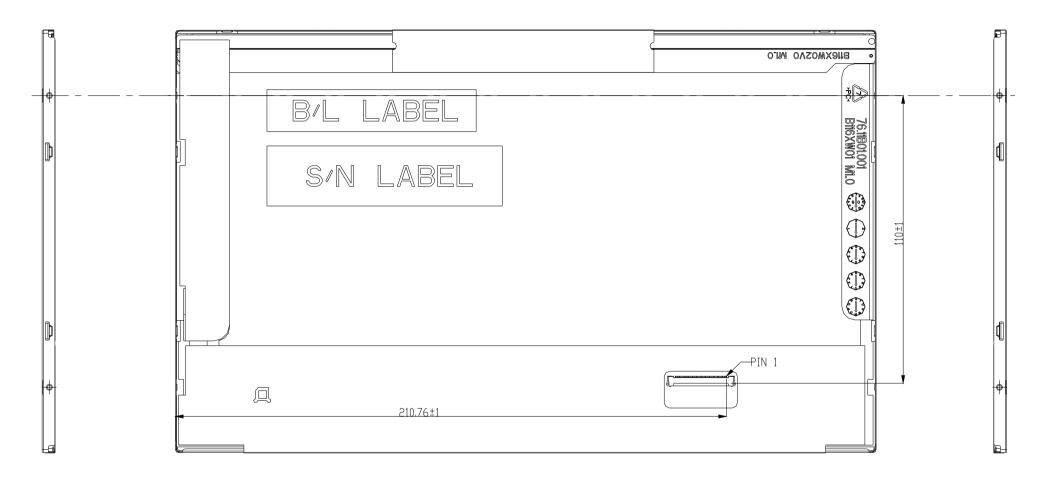
11.1 LCM Outline Dimension



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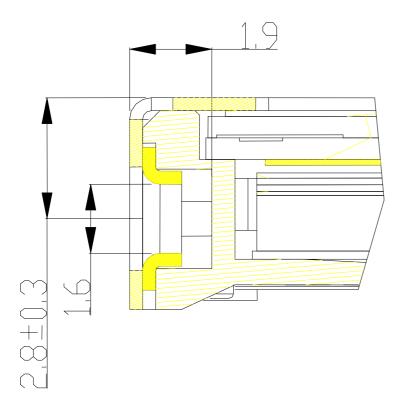
Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

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11.2 Screw Hole Depth and Center Position

Unit:mm.





12. Shipping and Package

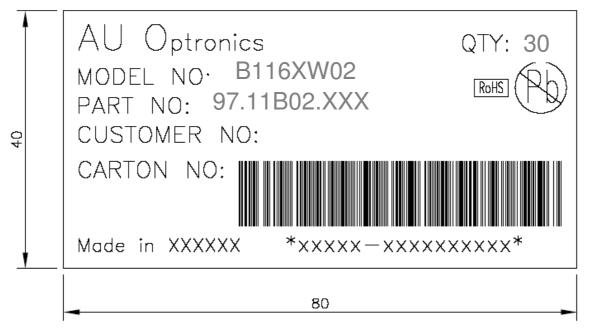
12.1 Shipping Label FormatSize :90 mm(length) x35mm(width)



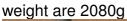


12.2 Carton package

Carton Label: 80mm * 40mm



The outside dimension of carton is 405(L)mm* 375(W)mm* 268(H)mm, carton and cushion





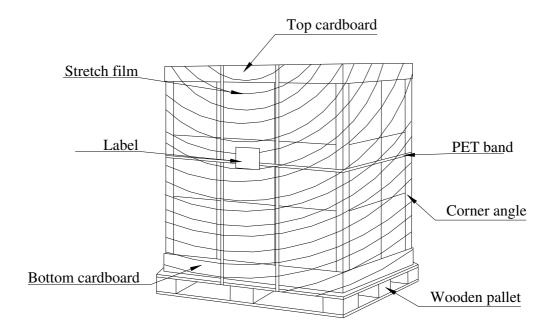


12.3 Shipping package of palletizing sequence

The outside dimension of Pallet is 114(L)mm* 89(W)mm* 13.8(H)mm

By air: 6 *5 layers, one pallet put 30 boxes, total 900 pcs module.

By sea: 6 *7 layers, one pallet put 42 boxes, total 1260 pcs module.





13. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	5C	01011100	92	
0B	hex, LSB first	20	00100000	32	
0C	32-bit ser #	00	0000000	0	
0D		00	0000000	0	
0E		00	0000000	0	
0F		00	0000000	0	
10	Week of manufacture	01	0000001	1	
11	Year of manufacture	12	00010010	18	
12	EDID Structure Ver.	01	0000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	1000000	128	
15	Max H image size (rounded to cm)	1A	00011010	26	
16	Max V image size (rounded to cm)	0E	00011010	14	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits) Blue/white low bits (Lower 2:2:2:2	99	10011001	153	
1A	bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	56	01010110	86	
1E	Green y	92	10010010	146	
1F	Blue x	28	00101000	40	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	0000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	



	AU OPTRON	103 00111	ONATION		
26	Standard timing #1	01	0000001	1	
27		01	0000001	1	
28	Standard timing #2	01	0000001	1	
29		01	0000001	1	
2A	Standard timing #3	01	0000001	1	
2B		01	0000001	1	
2C	Standard timing #4	01	0000001	1	
2D		01	0000001	1	
2E	Standard timing #5	01	0000001	1	
2F		01	0000001	1	
30	Standard timing #6	01	0000001	1	
31		01	0000001	1	
32	Standard timing #7	01	0000001	1	
33		01	0000001	1	
34	Standard timing #8	01	0000001	1	
35		01	0000001	1	
36	Pixel Clock/10000 LSB	20	00100000	32	
37	Pixel Clock/10000 USB	1C	00011100	28	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	80	10000000	128	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	23	00100011	35	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	20	00100000	32	
40	VertSync.Offset : VertSync.Width	36	00110110	54	
- 40	Horz‖ Sync Offset/Width Upper	30	00110110	J-1	
41	2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	00	00000000	0	
43	Vertical Image Size Lower 8bits Horizontal & Vertical Image Size	90	10010000	144	
44	(upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	0000000	0	
49	descriptor #2	00	0000000	0	
4 A	· ·	00	0000000	0	
4B		0F	00001111	15	
4C		00	0000000	0	
4D		00	0000000	0	
4E		00	0000000	0	
· · · · · · · · · · · · · · · · · · ·	1			<u> </u>	<u>i</u>



4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	0000000	0	
5D		FE	11111110	254	
5E		00	0000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62	Managaro	0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E	descriptor #4	00	00000000	0	
6F		FE	11111110	254	
70		00		0	
71	Manufacture P/N	42	00000000	66	В
			01000010		
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	31	00110001	49	1
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	58	01011000	88	X
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	32	00110010	50	2



7A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	BE	10111110	190	
			SUM	5888	

SUM to HEX 1700

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